AMENDMENT UNDER 37 C.F.R. § 1.312

Serial Number: 10/606,539 Filing Date: June 26, 2003

COMPACT SYSTEM MODULE WITH BUILT-IN THERMOELECTRIC COOLING Title:

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Conclusion

The specification has been amended to update the priority claim to include the issue date for parent Application No. 09/144,307.

Claims 50, 71 and 72 have been amended to correct typographical errors.

It is respectfully submitted that these changes do not introduce new matter, and the claims are allowable without further search or consideration. Therefore, entry is appropriate under Rule 312, and is respectfully requested.

Respectfully submitted,

KIE Y. AHN ET AL.

By their Representatives,

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Date 1-5-06	By MLB	
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CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: Mail Stop Issue Fee, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on this day of January, 2006.